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DATA SHEET

PART NO.: LT5050UVC-XPCA1

REV: <u>A / 0</u>

CUSTOMER'S APPROVAL:	DCC	•		
DRAWING NO.: DS-31P-20-0022	DATE: 2020-06-28	PAGE	1	



Part No.: LT5050UVC-XPCA1 REV:A/0

■ Features

*SIZE: 5.0*5.0*1.7mm

*Suitable for all SMT assembly and solder process

* Available on tape and reel

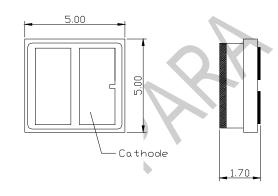
* Moisture sensitivity level: Level 5

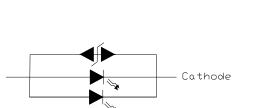
* RoHS compliant

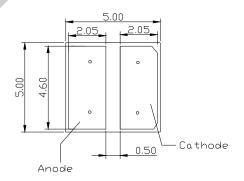
■ Applications

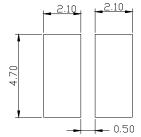
- * Ultraviolet disinfection
- * Phototherapy
- * Bio- Analysis/ Detection
- * General use

■ Package Dimensions









Recommended Pad Design Drawings

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.2mm unless otherwise noted



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■ Absolute Maximum Ratings(Ta=25°C)

Parameter	Symbol	Rating	Units	
Power Dissipation	PD	4.0	W	
Forward Current	IF	600	mA	
Operating Temperature	Topr	-10~ +55	$^{\circ}$	
Storage Temperature	Tstg	-30 ~ +85	${\mathbb C}$	
Junction Temperature	Tj	90	${\mathbb C}$	
Thermal Resistance	Rтн _J -s	15	K/W	

Notes:

- 1. 1/10 duty cycle o.1 ms pulse width
- 2. The above forward voltage measurement allowance tolerance is $\pm 0.1 \text{V}$
- 3. ESD<2000V

■ ELECTRO-OPTICAL CHARACTERISTICS: (Ta = 25°C)

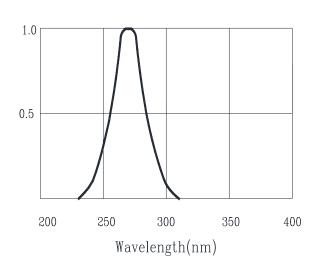
Parameter	Symbol	TEST	Min	Тур	Max.	Unit
Reverse Current	IR	VR=5V			5	μΑ
Forward Voltage	VF	IF=350mA		7.0		V
Total Radiant Flux	Фе	IF=600mA		80		mW
Peak wavelength	λр	IF=600mA		275±5		nm
Spectral Line Half - Width	Δλ	IF=600mA		11		nm
Half Intensity Angle	201/2	IF=600mA		120		deg

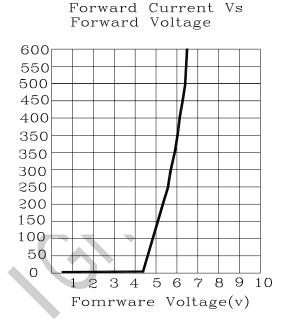


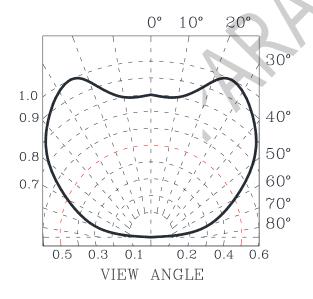
Part No.: LT5050UVC-XPCA1

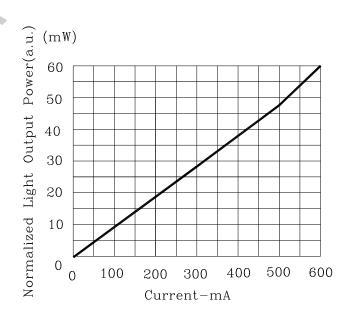
REV:A / 0

■ Typical Electro-Optical Characteristics







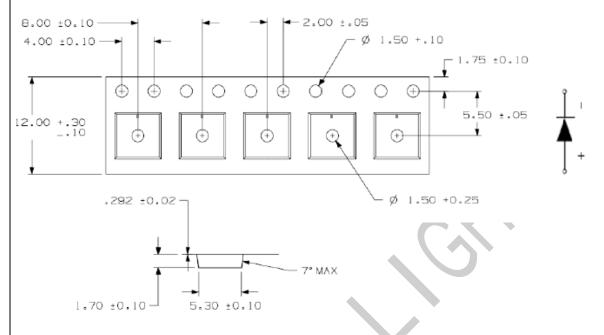




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■ Packaging

Carrier tape dimension



Package: 600pcs/reel

Reel Dimension

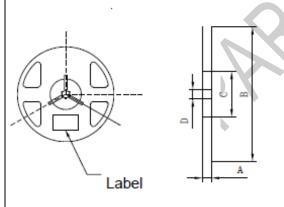


Table 2-1 Reel Dimension

Α	12±0.1mm
В	178±1mm
С	60±1mm
D	13.0±0.5mm

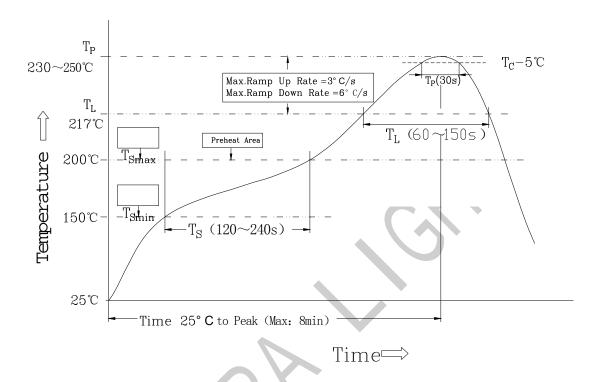
Fig.2-2 Reel Dimension

Notes: The tolerances unless mentioned ± 0.1 mm, Unit: mm



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■ SMT Reflow Soldering Instructions



Notes:

- 1. Reflow soldering should not be done more than two times. If more than 24 hours between the two soldering, LED will be damaged.
- 2. When soldering, do not put stress on the LEDS during heating.

Soldering ron

- 1. When do soldering by hand, keep the temperature of iron below less 300C less than 3 seconds
- 2. Soldering by hand should be done only one time

Repairing

Repairing should not be done after the LEDS have been soldered. When repairing is unavoidable, suitable tools must be used.

It should be confirmed in advance whether the characteristics of LEDS will or not be damaged by repairing.



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Cautions

- 1. The encapsulated material of the LEDS is silicone. Therefore the LEDS have a soft surface on the top of package. The pressure to the top surface will be impacted on the reliability of the LEDS. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when use the picking up nozzle, the pressure on the silicone resin should be proper.
- 2. Components should not be mounted on warped(non co plane)portion of PCB.After soldering,do not warp the circuit board.
- 3. Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering. Do not rapidly cool device after soldering.

■ Handling Precautions

Handle the component along the side surface by using forceps or appropriate tools; Do not directly touch or Handle the silicone lens surface, it may damage the internal circuitry.

■ Storage

	Conditions	Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	≤30°C	≤75%	Within 1 Year From Date
	After Opening Aluminum Bag	≤30°C	≤60%	24hours
	Baking	60±5°C	-	≥24hours

Notes

- 1. If the moisture absorbent material(silica gel) has faded away or the LEDS have exceeded the storage time, baking treatment should be performed after unpacking and based on the following condition(65 ± 5)°C for above 24 hours.
- 2. If the package is flatulence or damaged, please notify the sales staff to assist.
- 3. Similar to most Solid state devices; LEDS are sensitive to Electric-Static Discharge (ESD) and Electrical Over Stress (EOS).



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• PART NO. SYSTEM:

